

L Number	Hits	Search Text	DB	Time stamp
1	482	wafer and function\$ and segregat\$ and stress\$	USPAT; EPO; JPO; DERWENT; IBM_TDB	2002/06/18 13:45
2	5	(wafer and function\$ and segregat\$ and stress\$) and 324/754-767.ccls.	USPAT; EPO; JPO; DERWENT; IBM_TDB	2002/06/18 13:45
5	301	(wafer and function\$ and segregat\$ and stress\$) and speed	USPAT; EPO; JPO; DERWENT; IBM_TDB	2002/06/18 15:22
6	64	((wafer and function\$ and segregat\$ and stress\$) and speed) and 438/\$.ccls.	USPAT; EPO; JPO; DERWENT; IBM_TDB	2002/06/18 14:04
9	13	(wafer and function\$ and segregat\$ and stress\$) and operation\$ adj speed	USPAT; EPO; JPO; DERWENT; IBM_TDB	2002/06/18 15:23